

PCN Number:	20180219001	PCN Date:	February 20, 2018
Title:	Datasheet for TPS92630-Q1		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



TPS92630-Q1

SLVSC76C –FEBRUARY 2014–REVISED NOVEMBER 2017

Changes from Revision B (January 2015) to Revision C

Page

• Deleted the TPS92630-Q1 part number from page headers	1
• Changed TPS9263x-Q1 to TPS92630-Q1 in the data sheet title.....	1
• Deleted the "Two Options" bullet from the <i>Features</i> list	1
• Deleted the TPS92631-Q1 device from the <i>Device Information</i> table	1
• Changed pinout diagram	4
• Deleted the COMMENT column and moved the comment text to the DESCRIPTION column	4
• Added a row for thermal pad information	5
• Deleted specifications pertaining to the TPS92631-Q1 device	8
• Changed figure reference in the <i>FAULT Diagnostics</i> section to Figure 19	15
• Added the Receiving Notification of Documentation Updates and Community Resources sections.....	34



TPS92630-Q1

SLVSC76D –FEBRUARY 2014–REVISED JANUARY 2018

Changes from Revision C (November 2017) to Revision D

Page

• Changed pinout diagram	4
• Changed text for the <i>Thermal pad</i> row in the DESCRIPTION column	5

The datasheet number will be changing.

Device Family	Change From:	Change To:
TPS92630-Q1	SLVSC76B	SLVSC76C
TPS92630-Q1	SLVSC76C	SLVSC76D

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TPS92630-Q1>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:			
TPS92630QPWRQ1			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com